Transistor Panasonic

2SD0814, 2SD0814A (2SD814, 2SD814A)

Silicon NPN epitaxial planer type

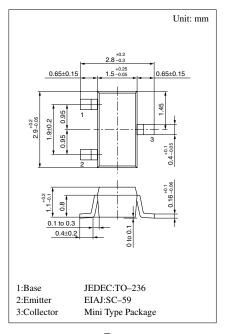
For high breakdown voltage low-frequency and low-noise amplification

Features

- ullet High collector to emitter voltage V_{CEO} .
- Low noise voltage NV.
- Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to	2SD0814	37	150	**	
base voltage	2SD0814A	V_{CBO}	185	V	
Collector to	2SD0814	37	150	V 7	
emitter voltage	2SD0814A	V_{CEO}	185	V	
Emitter to base voltage		V_{EBO}	5	V	
Peak collector current		I_{CP}	100	mA	
Collector current		I_{C}	50	mA	
Collector power dissipation		P _C	200	mW	
Junction temperature		T _j	150	°C	
Storage temperature		T_{stg}	−55 ~ +150	°C	



Marking symbol : P(2SD0814) L(2SD0814A)

Electrical Characteristics (Ta=25°C)

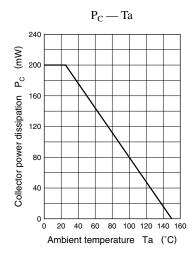
Paramete	er	Symbol	Conditions	min	typ	max	Unit
Collector cutoff curre	ent	I_{CBO}	$V_{CB} = 100V, I_E = 0$			1	μА
Collector to emitter	2SD0814	N/	I 1000A I 0	150			v
voltage	2SD0814A	V _{CEO}	$I_{\rm C} = 100 \mu A, I_{\rm B} = 0$	185			'
Emitter to base voltage	ge	V _{EBO}	$I_E = 10\mu A, I_C = 0$	5			V
Forward current transfer ratio ${\bf h}_{\rm FE}^{*}$ V		$V_{CE} = 5V, I_{C} = 10mA$	90		330		
Collector to emitter satu	uration voltage	V _{CE(sat)}	$I_C = 30 \text{mA}, I_B = 3 \text{mA}$			1	V
Transition frequency		f_T	$V_{CB} = 10V, I_E = -10mA, f = 200MHz$		150		MHz
Collector output capa	acitance	C _{ob}	$V_{CB} = 10V, I_{E} = 0, f = 1MHz$		2.3		pF
Noise voltage		NV	$V_{CE} = 10V$, $I_{C} = 1$ mA, $G_{V} = 80$ dB $R_{g} = 100$ k Ω , Function = FLAT		150		mV

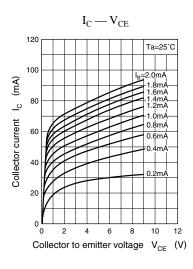
*hFE Rank classification

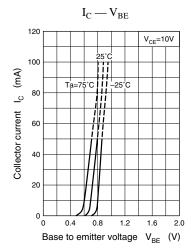
Rank		Q	R	S	
h _{FE}		90 ~ 155	130 ~ 220	185 ~ 330	
Marking	2SD0814	PQ	PR	PS	
Symbol	2SD0814A	LQ	LR	LS	

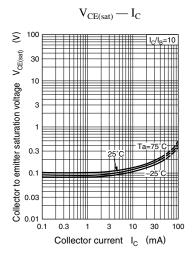
Note.) The Part numbers in the Parenthesis show conventional part number.

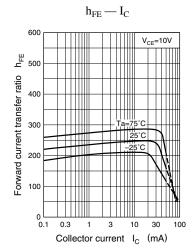
Panasonic 1

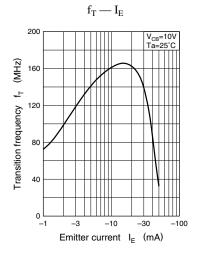


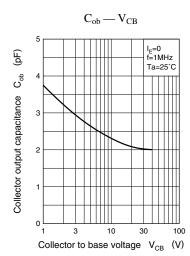












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